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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

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Product Status	Active
Core Processor	RL78
Core Size	16-Bit
Speed	24MHz
Connectivity	CSI, I²C, LINbus, UART/USART
Peripherals	DMA, LCD, LVD, POR, PWM, WDT
Number of I/O	58
Program Memory Size	96KB (96K x 8)
Program Memory Type	FLASH
EEPROM Size	4K x 8
RAM Size	6K x 8
Voltage - Supply (Vcc/Vdd)	1.6V ~ 5.5V
Data Converters	A/D 12x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	80-LQFP
Supplier Device Package	80-LQFP (12x12)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f10wmfafb-30

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Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

O ROM, RAM capacities

Flash ROM	Data Flash	RAM	RL78	3/L13
			64 pins	80 pins
128 KB	4 KB	8 KB ^{Note}	R5F10WLG	R5F10WMG
96 KB	4 KB	6 KB	R5F10WLF	R5F10WMF
64 KB	4 KB	4 KB	R5F10WLE	R5F10WME
48 KB	4 KB	2 KB	R5F10WLD	R5F10WMD
32 KB	4 KB	1.5 KB	R5F10WLC	R5F10WMC
16 KB	4 KB	1 KB	R5F10WLA	R5F10WMA

Note This is about 7 KB when the self-programming function and data flash function are used. (For details, see CHAPTER 3 in the RL78/L13 User's Manual.)



<R> 1.3.2 80-pin products

- 80-pin plastic LQFP (14 \times 14 mm, 0.65 mm pitch)
- 80-pin plastic LFQFP (12 × 12 mm, 0.5 mm pitch)



Caution Connect the REGC pin to Vss via a capacitor (0.47 to 1 μ F).

Remarks 1. For pin identification, see 1.4 Pin Identification.

 Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR). See Figure 4-8 Format of Peripheral I/O Redirection Register (PIOR) in the RL78/L13 User's Manual.



Parameter	Symbol	Conditions		MIN.	TYP.	MAX.	Unit
Input voltage, high	VIH1	P00 to P07, P10 to P17, P22 to P27, P30 to P35, P40 to P47, P50 to P57, P70 to P77, P125 to P127, P130, P137	Normal input buffer	0.8Vdd		Vdd	V
	VIH2	P03, P05, P06, P16, P17, P34, P43, P44, P46, P47, P53, P55	TTL input buffer 4.0 V \leq V _{DD} \leq 5.5 V	2.2		Vdd	V
			TTL input buffer $3.3 \text{ V} \leq \text{V}_{\text{DD}} < 4.0 \text{ V}$	2.0		Vdd	V
			TTL input buffer $1.6 \text{ V} \leq \text{V}_{\text{DD}} < 3.3 \text{ V}$	1.5		V_{DD}	V
	Vінз	P20, P21		0.7V _{DD}		Vdd	V
	VIH4	P60, P61		0.7Vdd		6.0	V
	VIH5	P121 to P124, P137, EXCLK, EXCLKS	, RESET	0.8VDD		Vdd	V
Input voltage, low	VIL1	P00 to P07, P10 to P17, P22 to P27, P30 to P35, P40 to P47, P50 to P57, P70 to P77, P125 to P127, P130, P137	Normal input buffer	0		0.2V _{DD}	V
	VIL2	P03, P05, P06, P16, P17, P34, P43, P44, P46, P47, P53, P55	TTL input buffer 4.0 V \leq V _{DD} \leq 5.5 V	0		0.8	V
			TTL input buffer $3.3 \text{ V} \leq \text{V}_{\text{DD}} < 4.0 \text{ V}$	0		0.5	V
			TTL input buffer 1.6 V \leq V _{DD} < 3.3 V	0		0.32	V
	VIL3	P20, P21		0		0.3VDD	V
	VIL4	P60, P61		0		0.3VDD	V
	VIL5	P121 to P124, P137, EXCLK, EXCLKS	, RESET	0		0.2VDD	V

 $(T_A = -40 \text{ to } +85^{\circ}C, 1.6 \text{ V} \le \text{V}_{DD} \le 5.5 \text{ V}, \text{V}_{SS} = 0 \text{ V})$

- Caution The maximum value of V_I of pins P00, P04 to P07, P16, P17, P35, P42 to P44, P46, P47, P53 to P56, and P130 is V_{DD}, even in the N-ch open-drain mode.
- **Remark** Unless specified otherwise, the characteristics of alternate-function pins are the same as those of the port pins.



(TA = -40 to +85°C, 1.6 V \leq VDD \leq 5.5 V, Vss = 0 V)

(2/2)

Parameter	Symbol			Conditions		MIN.	TYP.	MAX.	Unit
Supply	DD2Note 2	HALT	HS (high-speed	fHOCO = 48 MHz ^{Note 4} ,	V _{DD} = 5.0 V		0.71	1.95	mA
current ^{Note 1}		mode	main) mode ^{note} 7	fı⊢ = 24 MHz ^{Note 4}	V _{DD} = 3.0 V		0.71	1.95	
				fносо = 24 MHz ^{Note 4} ,	V _{DD} = 5.0 V		0.49	1.64	mA
				fı⊢ = 24 MHz ^{Note 4}	V _{DD} = 3.0 V		0.49	1.64	
				fносо = 16 MHz ^{Note 4} ,	V _{DD} = 5.0 V		0.43	1.11	mA
				fı⊢ = 16 MHz ^{Note 4}	V _{DD} = 3.0 V		0.43	1.11	
			LS (low-speed	fносо = 8 MHz ^{Note 4} ,	V _{DD} = 3.0 V		280	770	μA
			main) mode ^{note} 7	fiH = 8 MHz Note 4	V _{DD} = 2.0 V		280	770	
			LV (low-voltage	f _{HOCO} = 4 MHz ^{Note 4} ,	V _{DD} = 3.0 V		430	700	μA
			main) mode ^{Note 7}	f _{IH} = 4 MHz ^{Note 4}	V _{DD} = 2.0 V		430	700	
			HS (high-speed	f _{MX} = 20 MHz ^{Note 3} ,	Square wave input		0.31	1.42	mA
			main) mode ^{Note} 7	V _{DD} = 5.0 V	Resonator connection		0.48	1.42	
				f _{MX} = 20 MHz ^{Note 3} ,	Square wave input		0.29	1.42	mA
				V _{DD} = 3.0 V	Resonator connection		0.48	1.42	
				f _{MX} = 16 MHz ^{Note 3} ,	Square wave input		0.26	0.86	mA
				V _{DD} = 5.0 V	Resonator connection		0.45	1.15	
				f _{MX} = 16 MHz ^{Note 3} ,	Square wave input		0.25	0.86	mA
			V _{DD} = 3.0 V	Resonator connection		0.44	1.15		
			f _{MX} = 10 MHz ^{Note 3} ,	Square wave input		0.20	0.63	mA	
		V _{DD} = 5.0 V	Resonator connection		0.28	0.71			
				f _{MX} = 10 MHz ^{Note 3} ,	Square wave input		0.19	0.63	mA
				V _{DD} = 3.0 V	Resonator connection		0.28	0.71	
			LS (low-speed $f_{MX} = 8 \text{ MHz}^{Note 3}$,	f _{MX} = 8 MHz ^{Note 3} ,	Square wave input		100	560	μA
			main) mode ^{Note 7}	V _{DD} = 3.0 V	Resonator connection		160	560	
				f _{MX} = 8 MHz ^{Note 3} ,	Square wave input		100	560	μA
				V _{DD} = 2.0 V	Resonator connection		160	560	
			Subsystem	fsue = 32.768 kHz ^{Note 5} ,	Square wave input		0.34	0.62	μA
			clock operation	T _A = -40°C	Resonator connection		0.51	0.80	
				fsue = 32.768 kHz ^{Note 5} ,	Square wave input		0.38	0.62	μA
				T _A = +25°C	Resonator connection		0.57	0.80	
				f _{SUB} = 32.768 kHz ^{Note 5} ,	Square wave input		0.46	2.30	μA
				T _A = +50°C	Resonator connection		0.67	2.49	
				fsue = 32.768 kHz ^{Note 5} ,	Square wave input		0.65	4.03	μA
				TA = +70°C	Resonator connection		0.91	4.22	
				fsub = 32.768 kHz ^{Note 5} ,	Square wave input		1.00	8.04	μA
				TA - +03 C	Resonator connection		1.31	8.23	
	DD3 ^{Note 6}	STOP	T _A = -40°C				0.18	0.52	μA
		mode	T _A = +25°C				0.24	0.52	
			$T_A = +50^{\circ}C$				0.33	2.21	
			$I_A = +70^{\circ}C$				0.53	3.94	
			I _A = +85°C				0.93	7.95	

(Notes and Remarks are listed on the next page.)



- **Notes 1.** Total current flowing into V_{DD}, including the input leakage current flowing when the level of the input pin is fixed to V_{DD} or V_{SS}. The values below the MAX. column include the peripheral operation current. However, not including the current flowing into the LCD controller/driver, A/D converter, LVD circuit, comparator, I/O port, on-chip pull-up/pull-down resistors, and the current flowing during data flash rewrite.
 - 2. During HALT instruction execution by flash memory.
 - **3.** When high-speed on-chip oscillator and subsystem clock are stopped.
 - 4. When high-speed system clock and subsystem clock are stopped.
 - When high-speed on-chip oscillator and high-speed system clock are stopped.
 When RTCLPC = 1 and setting ultra-low current consumption (AMPHS1 = 1). The current flowing into the realtime clock 2 is included. However, not including the current flowing into the clock output/buzzer output, 12-bit interval timer, and watchdog timer.
 - **6.** Not including the current flowing into the real-time clock 2, clock output/buzzer output, 12-bit interval timer, and watchdog timer.
 - 7. Relationship between operation voltage width, operation frequency of CPU and operation mode is as below.
 - HS (high-speed main) mode: 2.7 V \leq V_{DD} \leq 5.5 V@1 MHz to 24 MHz
 - 2.4 V \leq V_{DD} \leq 5.5 V@1 MHz to 16 MHz
 - LS (low-speed main) mode: $1.8 \text{ V} \le \text{V}_{\text{DD}} \le 5.5 \text{ V}@1 \text{ MHz}$ to 8 MHz
 - LV (low-voltage main) mode: 1.6 V \leq V_{DD} \leq 5.5 V@1 MHz to 4 MHz
 - 8. Regarding the value for current to operate the subsystem clock in STOP mode, refer to that in HALT mode.
- **Remarks 1.** fMX: High-speed system clock frequency (X1 clock oscillation frequency or external main system clock frequency)
 - 2. fHOCO: High-speed on-chip oscillator clock frequency (48 MHz max.)
 - 3. fin: High-speed on-chip oscillator clock frequency (24 MHz max.)
 - **4.** fsub: Subsystem clock frequency (XT1 clock oscillation frequency)
 - 5. Except subsystem clock operation and STOP mode, temperature condition of the TYP. value is TA = 25°C



Notes 1. Current flowing to VDD.

- 2. When high speed on-chip oscillator and high-speed system clock are stopped.
- 3. Current flowing only to the real-time clock 2 (excluding the operating current of the low-speed on-chip oscillator and the XT1 oscillator). The value of the current for the RL78 microcontrollers is the sum of the values of either IDD1 or IDD2, and IRTC, when the real-time clock 2 operates in operation mode or HALT mode. When the low-speed on-chip oscillator is selected, IFIL should be added. IDD2 subsystem clock operation includes the operational current of real-time clock 2.
- 4. Current flowing only to the 12-bit interval timer (excluding the operating current of the low-speed on-chip oscillator and the XT1 oscillator). The value of the current for the RL78 microcontrollers is the sum of the values of either IDD1 or IDD2, and ITMKA, when the 12-bit interval timer operates in operation mode or HALT mode. When the low-speed on-chip oscillator is selected, IFIL should be added.
- 5. Current flowing only to the watchdog timer (including the operating current of the low-speed on-chip oscillator). The current value of the RL78 microcontrollers is the sum of IDD1, IDD2 or IDD3 and IWDT when the watchdog timer operates.
- 6. Current flowing only to the A/D converter. The current value of the RL78 microcontrollers is the sum of IDD1 or IDD2 and IADC when the A/D converter operates in an operation mode or the HALT mode.
- 7. Current flowing only to the LVD circuit. The current value of the RL78 microcontrollers is the sum of IDD1, IDD2 or IDD3 and ILVD when the LVD circuit operates.
- 8. Current flowing only during data flash rewrite.
- 9. Current flowing only during self programming.
 - 10. For shift time to the SNOOZE mode, see 21.3.3 SNOOZE mode in the RL78/L13 User's Manual.
- **11.** Current flowing only to the comparator circuit. The current value of the RL78 microcontrollers is the sum of IDD1, IDD2 or IDD3 and ICMP when the comparator circuit operates.
- 12. Current flowing only to the LCD controller/driver. The value of the current for the RL78 microcontrollers is the sum of the supply current (IDD1 or IDD2) and LCD operating current (ILCD1, ILCD2, or ILCD3), when the LCD controller/driver operates in operation mode or HALT mode. However, not including the current flowing into the LCD panel. Conditions of the TYP. value and MAX. value are as follows.
 - Setting 20 pins as the segment function and blinking all
 - Selecting fsub for system clock when LCD clock = 128 Hz (LCDC0 = 07H)
 - Setting four time slices and 1/3 bias
- **13.** Not including the current flowing into the external division resistor when using the external resistance division method.

Remarks 1. fiL: Low-speed on-chip oscillator clock frequency

- 2. fsub: Subsystem clock frequency (XT1 clock oscillation frequency)
- 3. fcLK: CPU/peripheral hardware clock frequency
- **4.** The temperature condition for the TYP. value is $T_A = 25^{\circ}C$.



(4) During communication at same potential (simplified I²C mode)

Parameter	Symbol	Conditions	HS (hig main)	h-speed Mode	LS (lov main)	v-speed Mode	LV (low main)	-voltage Mode	Unit
			MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
SCLr clock frequency	fsc∟	$\begin{array}{l} 2.7 \; V \leq V_{\text{DD}} \leq 5.5 \; V, \\ C_{\text{b}} = 50 \; pF, \; R_{\text{b}} = 2.7 \; k\Omega \end{array}$		1000 ^{Note} 1		400 ^{Note 1}		400 ^{Note 1}	kHz
		$\label{eq:VDD} \begin{array}{l} 1.8 \mbox{ V} \mbox{ (2.4 V}^{\mbox{Note 3}}) \leq V_{\mbox{DD}} \leq 5.5 \mbox{ V}, \\ C_{\mbox{b}} = 100 \mbox{ pF}, \mbox{ R}_{\mbox{b}} = 3 k\Omega \end{array}$		400 ^{Note 1}		400 ^{Note 1}		400 ^{Note 1}	kHz
		$\begin{array}{l} 1.8 \ V \ (2.4 \ V^{\text{Note 3}}) \leq V_{\text{DD}} < 2.7 \ V, \\ C_b = 100 \ pF, \ R_b = 5 \ k\Omega \end{array}$		300 ^{Note 1}		300 ^{Note 1}		300 ^{Note 1}	kHz
		$\label{eq:VDD} \begin{array}{l} 1.6 \mbox{ V} \leq \mbox{ V}_{\mbox{DD}} < 1.8 \mbox{ V}, \\ C_b = 100 \mbox{ pF}, \mbox{ R}_b = 5 \mbox{ k}\Omega \end{array}$		-		-		250 ^{Note 1}	kHz
Hold time when SCLr = "L"	t LOW	$\label{eq:VDD} \begin{array}{l} 2.7 \mbox{ V} \leq \mbox{V}_{\mbox{DD}} \leq 5.5 \mbox{ V}, \\ C_b = 50 \mbox{ pF}, \mbox{ R}_b = 2.7 \mbox{ k}\Omega \end{array}$	475		1150		1150		ns
		$\label{eq:VDD} \begin{array}{l} 1.8 \mbox{ V} \ (2.4 \mbox{ V}^{\mbox{Note 3}}) \leq V_{\mbox{DD}} \leq 5.5 \mbox{ V}, \\ C_b = 100 \mbox{ pF}, \mbox{ R}_b = 3 \mbox{ k}\Omega \end{array}$	1150		1150		1150		ns
		$\begin{array}{l} 1.8 \; V \; (2.4 \; V^{\text{Note 3}}) \leq V_{\text{DD}} < 2.7 \; V, \\ C_{\text{b}} = 100 \; pF, \; R_{\text{b}} = 5 \; k\Omega \end{array}$	1550		1550		1550		ns
		$\label{eq:VDD} \begin{array}{l} 1.6 \mbox{ V} \leq \mbox{ V}_{DD} < 1.8 \mbox{ V}, \\ C_b = 100 \mbox{ pF}, \mbox{ R}_b = 5 \mbox{ k}\Omega \end{array}$	_		_		1850		ns
Hold time when SCLr = "H"	tніgн	$\label{eq:def_def_def} \begin{array}{l} 2.7 \ V \leq V_{DD} \leq 5.5 \ V, \\ C_b = 50 \ pF, \ R_b = 2.7 \ k\Omega \end{array}$	475		1150		1150		ns
			1150		1150		1150		ns
			1550		1550		1550		ns
		$\label{eq:DD} \begin{array}{l} 1.6 \mbox{ V} \leq \mbox{ V}_{DD} < 1.8 \mbox{ V}, \\ C_b = 100 \mbox{ pF}, \mbox{ R}_b = 5 \mbox{ k}\Omega \end{array}$	-		-		1850		ns
Data setup time (reception)	tsu:dat	$\label{eq:def_def_def} \begin{array}{l} 2.7 \mbox{ V} \leq \mbox{V}_{\mbox{DD}} \leq 5.5 \mbox{ V}, \\ C_b = 50 \mbox{ pF}, \mbox{ R}_b = 2.7 \mbox{ k}\Omega \end{array}$	1/f _{МСК} + 85 ^{Note 2}		1/f _{МСК} + 145 ^{Note 2}		1/f _{МСК} + 145 ^{Note 2}		ns
		$\label{eq:VDD} \begin{array}{l} 1.8 \mbox{ V} \ (2.4 \mbox{ V}^{\mbox{Note 3}}) \leq V_{\mbox{DD}} \leq 5.5 \mbox{ V}, \\ C_{\mbox{b}} = 100 \mbox{ pF}, \mbox{ R}_{\mbox{b}} = 3 k\Omega \end{array}$	1/f _{МСК} + 145 ^{Note 2}		1/f _{МСК} + 145 ^{Note 2}		1/f _{МСК} + 145 ^{Note 2}		ns
			1/f _{мск} + 230 ^{Note 2}		1/fмск+ 230 ^{Note 2}		1/f _{MCK} + 230 ^{Note 2}		ns
		$\label{eq:DD} \begin{array}{l} 1.6 \mbox{ V} \leq \mbox{ V}_{DD} < 1.8 \mbox{ V}, \\ C_b = 100 \mbox{ pF}, \mbox{ R}_b = 5 \mbox{ k}\Omega \end{array}$	-		-		1/f _{MCK} + 290 ^{Note 2}		ns
Data hold time (transmission)	thd:dat	$\begin{array}{l} 2.7 \ V \leq V_{DD} \leq 5.5 \ V, \\ C_b = 50 \ pF, \ R_b = 2.7 \ k\Omega \end{array} \end{array} \label{eq:eq:constraint}$	0	305	0	305	0	305	ns
		$\label{eq:VDD} \hline \begin{array}{ c c c c c } 1.8 \ V \ (2.4 \ V^{\text{Note 3}}) \leq V_{\text{DD}} \leq 5.5 \ V, \\ C_{b} = 100 \ pF, \ R_{b} = 3 \ k\Omega \end{array}$	0	355	0	355	0	355	ns
		$\label{eq:VDD} \hline $ $ 1.8 \ V \ (2.4 \ V^{\mbox{Note 3}}) \le V_{\mbox{DD}} < 2.7 \ V, $$ $ $ $ $ $ $ $ $ $ $ $ $ $ $ $ $ $$	0	405	0	405	0	405	ns
		1.6 $V \le V_{DD} <$ 1.8 V, C _b = 100 pF, R _b = 5 kΩ	-	_	_	_	0	405	ns

$(T_A = -40 \text{ to } +85^{\circ}\text{C}, 1.6 \text{ V} \le \text{V}_{DD} \le 5.5 \text{ V}, \text{ V}_{SS} = 0 \text{ V})$

(Notes, Caution, and Remarks are listed on the next page.)

(6) Communication at different potential (2.5 V, 3 V) (CSI mode) (master mode, SCKp... internal clock output, corresponding CSI00 only)

Parameter	Symbol		Conditions	HS (higl main)	HS (high-speed main) Mode		-speed Mode	LV (low-voltage main) Mode		Unit
				MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
SCKp cycle time	tксүı	tксү1 ≥ 2 /fc∟к		200		1150		1150		ns
			$\label{eq:2.7} \begin{array}{l} 2.7 \ V \leq V_{DD} < 4.0 \ V, \\ 2.3 \ V \leq V_b \leq 2.7 \ V, \\ C_b = 20 \ pF, \ R_b = 2.7 \ k\Omega \end{array}$	300		1150		1150		ns
SCKp high-level width	tкнı	$\begin{array}{l} 4.0 \ V \leq V_{\text{DD}} \leq 5. \\ C_{\text{b}} = 20 \ pF, \ R_{\text{b}} \end{array} \end{array}$	5 V, 2.7 V ≤ V₅ ≤ 4.0 V, = 1.4 kΩ	tксү1/2 — 50		tксү1/2 — 50		tксү1/2 — 50		ns
		$2.7 \text{ V} \le \text{V}_{\text{DD}} < 4.$ $C_{\text{b}} = 20 \text{ pF}, \text{ R}_{\text{b}} = 10 \text{ pF}$	0 V, 2.3 V ≤ V _b ≤ 2.7 V, = 2.7 kΩ	tксү1/2 — 120		tксү1/2 — 120		tксү1/2 — 120		ns
SCKp low-level width	tĸ∟1	$\begin{array}{l} 4.0 \ V \leq V_{\text{DD}} \leq 5. \\ C_{\text{b}} = 20 \ pF, \ R_{\text{b}} = \end{array}$	5 V, 2.7 V ≤ V₅ ≤ 4.0 V, = 1.4 kΩ	tксү1/2 — 7		tксү1/2 — 50		tксү1/2 — 50		ns
		$2.7 \text{ V} \le \text{V}_{\text{DD}} < 4.$ $C_{\text{b}} = 20 \text{ pF}, \text{ R}_{\text{b}} = 10 \text{ pF}$	0 V, 2.3 V ≤ V₅ ≤ 2.7 V, = 2.7 kΩ	tксү1/2 – 10		tксү1/2 — 50		tксү1/2 — 50		ns
SIp setup time (to SCKp↑) ^{Note 1}	tsiĸ1	$\begin{array}{l} 4.0 \ V \leq V_{\text{DD}} \leq 5. \\ C_{\text{b}} = 20 \ pF, \ R_{\text{b}} = \end{array}$	5 V, 2.7 V ≤ V₅ ≤ 4.0 V, = 1.4 kΩ	58		479		479		ns
		$2.7 \text{ V} \le \text{V}_{\text{DD}} < 4.$ $C_{\text{b}} = 20 \text{ pF}, \text{ R}_{\text{b}} = 10 \text{ pF}$	0 V, 2.3 V ≤ V₅ ≤ 2.7 V, = 2.7 kΩ	121		479		479		ns
SIp hold time (from SCKp↑) ^{Note}	tksi1	$\begin{array}{l} 4.0 \ V \leq V_{\text{DD}} \leq 5. \\ C_{\text{b}} = 20 \ pF, \ R_{\text{b}} \end{array} \end{array} \label{eq:eq:constraint}$	5 V, 2.7 V ≤ V₅ ≤ 4.0 V, = 1.4 kΩ	10		10		10		ns
1		$2.7 \text{ V} \le \text{V}_{\text{DD}} < 4.$ $C_{\text{b}} = 20 \text{ pF}, \text{R}_{\text{b}} = 10 \text{ pF}$	0 V, 2.3 V ≤ V₅ ≤ 2.7 V, = 2.7 kΩ	10		10		10		ns
Delay time from SCKp↓ to	tkso1	$\begin{array}{l} 4.0 \ V \leq V_{\text{DD}} \leq 5. \\ C_{\text{b}} = 20 \ pF, \ R_{\text{b}} \end{array} \end{array}$	5 V, 2.7 V ≤ V₅ ≤ 4.0 V, = 1.4 kΩ		60		60		60	ns
SOp output ^{Note 1}		$2.7 \text{ V} \le \text{V}_{\text{DD}} \le 4.$ $C_{\text{b}} = 20 \text{ pF}, \text{ R}_{\text{b}} = 10 \text{ pF}$	0 V, 2.3 V ≤ V₅ ≤ 2.7 V, = 2.7 kΩ		130		130		130	ns
SIp setup time (to SCKp↓) ^{Note 2}	tsik1	$\begin{array}{l} 4.0 \ V \leq V_{\text{DD}} \leq 5. \\ C_{\text{b}} = 20 \ pF, \ R_{\text{b}} = \end{array}$	5 V, 2.7 V ≤ V₅ ≤ 4.0 V, = 1.4 kΩ	23		110		110		ns
		$2.7 \text{ V} \le \text{V}_{\text{DD}} \le 4.$ C _b = 20 pF, R _b =	0 V, 2.3 V ≤ V₅ ≤ 2.7 V, = 2.7 kΩ	33		110		110		ns
SIp hold time (from SCKp↓) ^{Note}	tksi1	$\begin{array}{l} 4.0 \ V \leq V_{\text{DD}} \leq 5. \\ C_{\text{b}} = 20 \ pF, \ R_{\text{b}} = \end{array} \end{array}$	5 V, 2.7 V ≤ V₅ ≤ 4.0 V, = 1.4 kΩ	10		10		10		ns
2		$2.7 V \le V_{DD} < 4.$ C _b = 20 pF, R _b =	0 V, 2.3 V \leq V _b \leq 2.7 V, = 2.7 kΩ	10		10		10		ns
Delay time from SCKp↑ to	tkso1	$\begin{array}{l} 4.0 \ V \leq V_{\text{DD}} \leq 5. \\ C_{\text{b}} = 20 \ p\text{F}, \ R_{\text{b}} = \end{array} \end{array}$	5 V, 2.7 V \leq V _b \leq 4.0 V, = 1.4 kΩ		10		10		10	ns
SOp output ^{Note 2}		$2.7 \text{ V} \le \text{V}_{\text{DD}} < 4.$ $C_{\text{b}} = 20 \text{ pF}, \text{ R}_{\text{b}} = 10 \text{ pF}$	0 V, 2.3 V \leq V _b \leq 2.7 V, = 2.7 kΩ		10		10		10	ns

 $(T_A = -40 \text{ to } +85^{\circ}\text{C}, 2.7 \text{ V} \le V_{DD} \le 5.5 \text{ V}, \text{ V}_{SS} = 0 \text{ V})$

(Notes, Caution and Remarks are listed on the next page.)

(9) Communication at different potential (1.8 V, 2.5 V, 3 V) (simplified I²C mode) (2/2)

Parameter	Symbol	Conditions	HS (higl main)	n-speed Mode	LS (low-speed main) Mode		LV (low- main)	-voltage Mode	Unit
			MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
Data setup time (reception)	tsu:dat		1/f _{МСК} + 135 ^{Note 4}		1/f _{МСК} + 190 ^{Note 4}		1/f _{МСК} + 190 ^{Note 4}		ns
		$\begin{array}{l} 2.7 \ V \leq V_{DD} < 4.0 \ V, \\ 2.3 \ V \leq V_b \leq 2.7 \ V, \\ C_b = 50 \ pF, \ R_b = 2.7 \ k\Omega \end{array}$	1/f _{МСК} + 135 ^{Note 4}		1/f _{МСК} + 190 ^{Note 4}		1/f _{МСК} + 190 ^{Note 4}		ns
		$\begin{array}{l} 4.0 \ V \leq V_{DD} \leq 5.5 \ V, \\ 2.7 \ V \leq V_b \leq 4.0 \ V, \\ C_b = 100 \ pF, \ R_b = 2.8 \ k\Omega \end{array}$	1/f _{MCK} + 190 ^{Note 4}		1/f _{МСК} + 190 ^{Note 4}		1/f _{МСК} + 190 ^{Note 4}		ns
		$\begin{array}{l} 2.7 \; V \leq V_{DD} < 4.0 \; V, \\ 2.3 \; V \leq V_b \leq 2.7 \; V, \\ C_b = 100 \; pF, \; R_b = 2.7 \; k\Omega \end{array}$	1/f _{МСК} + 190 ^{Note 4}		1/f _{МСК} + 190 ^{Note 4}		1/f _{МСК} + 190 ^{Note 4}		ns
		$\begin{split} & 1.8 \ \text{V} \ (2.4 \ \text{V}^{\text{Note 2}}) \leq \text{V}_{\text{DD}} < 3.3 \ \text{V}, \\ & 1.6 \ \text{V} \leq \text{V}_{\text{b}} \leq 2.0 \ \text{V}^{\text{Note 3}}, \\ & \text{C}_{\text{b}} = 100 \ \text{pF}, \ \text{R}_{\text{b}} = 5.5 \ \text{k}\Omega \end{split}$	1/f _{МСК} + 190 ^{Note 4}		1/f _{МСК} + 190 ^{Note 4}		1/f _{МСК} + 190 ^{Note 4}		ns
Data hold time (transmission)	thd:dat	$\begin{array}{l} 4.0 \ V \leq V_{DD} \leq 5.5 \ V, \\ 2.7 \ V \leq V_b \leq 4.0 \ V, \\ C_b = 50 \ pF, \ R_b = 2.7 \ k\Omega \end{array}$	0	305	0	305	0	305	ns
		$\begin{array}{l} 2.7 \ V \leq V_{DD} < 4.0 \ V, \\ 2.3 \ V \leq V_b \leq 2.7 \ V, \\ C_b = 50 \ pF, \ R_b = 2.7 \ k\Omega \end{array}$	0	305	0	305	0	305	ns
		$\begin{array}{l} 4.0 \ V \leq V_{DD} \leq 5.5 \ V, \\ 2.7 \ V \leq V_b \leq 4.0 \ V, \\ C_b = 100 \ pF, \ R_b = 2.8 \ k\Omega \end{array}$	0	355	0	355	0	355	ns
		$\begin{array}{l} 2.7 \ V \leq V_{DD} < 4.0 \ V, \\ 2.3 \ V \leq V_b \leq 2.7 \ V, \\ C_b = 100 \ pF, \ R_b = 2.7 \ k\Omega \end{array}$	0	355	0	355	0	355	ns
		$\begin{split} & 1.8 \ \text{V} \ (2.4 \ \text{V}^{\text{Note } 2}) \leq \text{V}_{\text{DD}} < 3.3 \ \text{V}, \\ & 1.6 \ \text{V} \leq \text{V}_{\text{b}} \leq 2.0 \ \text{V}^{\text{Note } 3}, \\ & \text{C}_{\text{b}} = 100 \ \text{pF}, \ \text{R}_{\text{b}} = 5.5 \ \text{k}\Omega \end{split}$	0	405	0	405	0	405	ns

 $(T_A = -40 \text{ to } +85^{\circ}\text{C}, 1.8 \text{ V} \le \text{V}_{DD} \le 5.5 \text{ V}, \text{ V}_{SS} = 0 \text{ V})$

Notes 1. The value must also be equal to or less than $f_{MCK}/4$.

- 2. Condition in HS (high-speed main) mode
- 3. Use it with $V_{DD} \ge V_b$.
- **4.** Set the fMCK value to keep the hold time of SCLr = "L" and SCLr = "H".
- Caution Select the TTL input buffer and the N-ch open drain output (V_{DD} tolerance) mode for the SDAr pin and the N-ch open drain output (V_{DD} tolerance) mode for the SCLr pin by using port input mode register g (PIMg) and port output mode register g (POMg). For V_{IH} and V_{IL}, see the DC characteristics with TTL input buffer selected.

(**Remarks** are listed on the next page.)



Simplified I²C mode connection diagram (during communication at different potential)



Simplified I²C mode serial transfer timing (during communication at different potential)



- **Remarks 1.** R_b[Ω]: Communication line (SDAr, SCLr) pull-up resistance, C_b[F]: Communication line (SDAr, SCLr) load capacitance, V_b[V]: Communication line voltage
 - **2.** r: IIC number (r = 00, 10), g: PIM, POM number (g = 0, 1)
 - fMCK: Serial array unit operation clock frequency
 (Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn).
 m: Unit number, n: Channel number (mn = 00, 02)



2.5.2 Serial interface IICA

(1) I²C standard mode (1/2)

(TA = -40 to +85°C, 1.6 V \leq VDD \leq 5.5 V, Vss = 0 V)

Parameter	Symbol	C	Conditions	HS (hig main)	h-speed Mode	LS (low main)	/-speed Mode	LV (low main)	LV (low-voltage main) Mode	
				MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
SCLA0 clock	fsc∟	Normal	$2.7~V \leq V_{\text{DD}} \leq 5.5~V$	0	100	0	100	0	100	kHz
frequency		mode: fc∟к ≥ 1 MHz	$\begin{array}{l} 1.8 \ V \ (2.4 \ V^{\text{Note 3}}) \leq \\ V_{\text{DD}} \leq 5.5 \ V \end{array}$	0	100	0	100	0	100	kHz
			$1.6~V \leq V_{\text{DD}} \leq 5.5~V$	Ι	_	Ι	-	0	100	kHz
Setup time of	tsu:sta	$2.7 V \leq V_{DD} \leq$	≦5.5 V	4.7		4.7		4.7		μs
restart condition		$1.8 \text{ V} (2.4 \text{ V}^{\text{Note 3}}) \le \text{V}_{\text{DD}} \le 5.5 \text{ V}$		4.7		4.7		4.7		μs
		$1.6 V \le V_{DD} \le$	$1.6~V \leq V_{\text{DD}} \leq 5.5~V$		_	1	_	4.7		μs
Hold time ^{Note 1}	thd:sta	$2.7 V \le V_{DD} \le$	≦5.5 V	4.0		4.0		4.0		μs
		1.8 V (2.4 V	Note 3) \leq VDD \leq 5.5 V	4.0		4.0		4.0		μs
		$1.6 V \le V_{DD} \le$	≤5.5 V	-	-	-	-	4.0		μs
Hold time when	t LOW	$2.7 V \le V_{DD} \le$	≤5.5 V	4.7		4.7		4.7		μs
SCLA0 = "L"		1.8 V (2.4 V	Note 3) \leq VDD \leq 5.5 V	4.7		4.7		4.7		μs
		$1.6 V \le V_{DD} \le$	≤5.5 V	-	-	-	-	4.7		μs
Hold time when	t high	$2.7 V \le V_{DD} \le$	≤5.5 V	4.0		4.0		4.0		μs
SCLA0 = "H"		1.8 V (2.4 V	Note 3) \leq VDD \leq 5.5 V	4.0		4.0		4.0		μs
		1.6 V ≤ V _{DD} ≤	5.5 V	_	_	-	_	4.0		μs

(Notes, Caution and Remark are listed on the next page.)



(3) I²C fast mode plus

 $(T_A = -40 \text{ to } +85^{\circ}\text{C}, 1.6 \text{ V} \le \text{V}_{DD} \le 5.5 \text{ V}, \text{ V}_{SS} = 0 \text{ V})$

Parameter	Symbol	Сог	nditions	HS (hig main)	h-speed Mode	LS (lov main)	/-speed Mode	LV (low main)	-voltage Mode	Unit
				MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
SCLA0 clock frequency	fscL	Fast mode plus: fcικ ≥ 10 MHz	$\begin{array}{l} 2.7 \ V \leq V_{\text{DD}} \leq \\ 5.5 \ V \end{array}$	0	1000		-	-	-	kHz
Setup time of restart condition	tsu:sta	$2.7 \text{ V} \leq V_{\text{DD}}$	≤5.5 V	0.26		-	-	-	-	μs
Hold time ^{Note 1}	thd:sta	$2.7 \text{ V} \leq \text{V}_{\text{DD}}$	≤5.5 V	0.26		-	_	-	-	μs
Hold time when SCLA0 ="L"	t LOW	$2.7 \text{ V} \leq \text{V}_{\text{DD}}$	≤5.5 V	0.5			-	-	-	μs
Hold time when SCLA0 ="H"	tніgн	$2.7 \text{ V} \leq \text{V}_{\text{DD}}$	≤5.5 V	0.26			-	-	-	μs
Data setup time (reception)	tsu:dat	$2.7 \text{ V} \leq \text{V}_{\text{DD}}$	≤5.5 V	50			-	-	-	ns
Data hold time (transmission) ^{Note 2}	thd:dat	$2.7 \text{ V} \leq \text{V}_{\text{DD}}$	≤5.5 V	0	0.45		-	-	-	μs
Setup time of stop condition	tsu:sto	$2.7 \text{ V} \leq \text{V}_{\text{DD}}$	≤5.5 V	0.26			-	-	-	μs
Bus-free time	t BUF	$2.7 \text{ V} \leq \text{V}_{\text{DD}}$	≤ 5.5 V	0.5			-	-	-	μs

Notes 1. The first clock pulse is generated after this period when the start/restart condition is detected.

2. The maximum value (MAX.) of the during normal transfer and a wait state is inserted in the ACK (acknowledge) timing.

- Caution The values in the above table are applied even when bit 2 (PIOR2) in the peripheral I/O redirection register (PIOR) is 1. At this time, the pin characteristics (IOH1, IOL1, VOH1, VOL1) must satisfy the values in the redirect destination.
- **Remark** The maximum value of C_b (communication line capacitance) and the value of R_b (communication line pull-up resistor) at that time in each mode are as follows.

Fast mode plus: C_b = 120 pF, R_b = 1.1 k Ω

IICA serial transfer timing





Notes 1. Excludes quantization error ($\pm 1/2$ LSB).

- 2. This value is indicated as a ratio (%FSR) to the full-scale value.
- When AV_{REFP} < V_{DD}, the MAX. values are as follows.
 Overall error: Add ±4 LSB to the MAX. value when AV_{REFP} = V_{DD}.
 Zero-scale error/Full-scale error: Add ±0.2%FSR to the MAX. value when AV_{REFP} = V_{DD}.
 Integral linearity error/ Differential linearity error: Add ±2 LSB to the MAX. value when AV_{REFP} = V_{DD}.
- **4.** Values when the conversion time is set to 57 μ s (min.) and 95 μ s (max.).
- 5. See 2.6.2 Temperature sensor/internal reference voltage characteristics.
- (2) When reference voltage (+) = V_{DD} (ADREFP1 = 0, ADREFP0 = 0), reference voltage (-) = V_{ss} (ADREFM = 0), target pins: ANI0, ANI1, ANI16 to ANI25, internal reference voltage, and temperature sensor output voltage

 $(T_A = -40 \text{ to } +85^{\circ}\text{C}, 1.6 \text{ V} \le \text{V}_{DD} \le 5.5 \text{ V}, \text{ V}_{SS} = 0 \text{ V}, \text{ Reference voltage (+)} = \text{V}_{DD}, \text{ Reference voltage (-)} = \text{V}_{SS})$

Parameter	Symbol	Co	nditions	MIN.	TYP.	MAX.	Unit
Resolution	RES			8		10	bit
Overall error ^{Notes 1, 2}	AINL	10-bit resolution	$1.8~V \leq V_{\text{DD}} \leq 5.5~V$		1.2	±7.0	LSB
			$1.6~V \leq V_{\text{DD}} \leq 5.5~V^{\text{Note 3}}$		1.2	±10.5	LSB
Conversion time	t CONV	10-bit resolution	$3.6~V \leq V_{\text{DD}} \leq 5.5~V$	2.125		39	μs
		Target pin:	$2.7~V \leq V_{\text{DD}} \leq 5.5~V$	3.1875		39	μs
		ANIU, ANI1, ANI16 to ANI25 ^{Note 3}	$1.8~V \leq V_{\text{DD}} \leq 5.5~V$	17		39	μs
			$1.6~V \leq V_{\text{DD}} \leq 5.5~V$	57		95	μs
		10-bit resolution	$3.6~V \leq V_{\text{DD}} \leq 5.5~V$	2.375		39	μs
		Target pin: Internal	$2.7~V \leq V_{\text{DD}} \leq 5.5~V$	3.5625		39	μs
		reference voltage, and temperature sensor output voltage (HS (high-speed main) mode)	$2.4~V \leq V_{DD} \leq 5.5~V$	17		39	μs
Zero-scale error ^{Notes 1, 2}	Fzs	10-bit resolution	18V <vpp<55v< td=""><td></td><td></td><td>+0.60</td><td>%ESR</td></vpp<55v<>			+0.60	%ESR
	-20		$1.6 \text{ V} \leq \text{V}_{\text{DD}} \leq 5.5 \text{ V}^{\text{Note 3}}$			±0.85	%FSR
Full-scale error ^{Notes 1, 2}	Ers	10-bit resolution	$1.8 \text{ V} \leq \text{V}_{\text{DD}} \leq 5.5 \text{ V}$			±0.60	%FSR
			$1.6 \text{ V} \le \text{V}_{\text{DD}} \le 5.5 \text{ V}^{\text{Note 3}}$			±0.85	%FSR
Integral linearity error ^{Note 1}	ILE	10-bit resolution	$1.8~V \leq V_{\text{DD}} \leq 5.5~V$			±4.0	LSB
			$1.6~V \leq V_{\text{DD}} \leq 5.5~V^{\text{Note 3}}$			±6.5	LSB
Differential linearity error Note	DLE	10-bit resolution	$1.8~V \leq V_{\text{DD}} \leq 5.5~V$			±2.0	LSB
1			$1.6~V \leq V_{\text{DD}} \leq 5.5~V^{\text{Note 3}}$			±2.5	LSB
Analog input voltage	VAIN	ANIO, ANI1, ANI16 to A	NI25	0		Vdd	V
		Internal reference voltation (2.4 V \leq V _{DD} \leq 5.5 V, HS	ge S (high-speed main) mode))		VBGR ^{Note 4}		V
		Temperature sensor ou (2.4 V \leq V _{DD} \leq 5.5 V, HS	tput voltage S (high-speed main) mode))	Ň	/TMPS25 ^{Note}	4	V

Notes 1. Excludes quantization error ($\pm 1/2$ LSB).

- **2.** This value is indicated as a ratio (%FSR) to the full-scale value.
- 3. Values when the conversion time is set to 57 μ s (min.) and 95 μ s (max.).
- 4. See 2.6.2 Temperature sensor/internal reference voltage characteristics.



2.6.5 LVD circuit characteristics

LVD Detection Voltage of Reset Mode and Interrupt Mode

(TA = -40 to +85°C, VPDR \leq VDD \leq 5.5 V, Vss = 0 V)

	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Detection	Supply voltage level	VLVD0	When power supply rises	3.98	4.06	4.14	V
voltage			When power supply falls	3.90	3.98	4.06	V
		VLVD1	When power supply rises	3.68	3.75	3.82	V
			When power supply falls	3.60	3.67	3.74	V
		VLVD2	When power supply rises	3.07	3.13	3.19	V
			When power supply falls	3.00	3.06	3.12	V
		VLVD3	When power supply rises	2.96	3.02	3.08	V
			When power supply falls	2.90	2.96	3.02	V
			When power supply rises	2.86	2.92	2.97	V
			When power supply falls	2.80	2.86	2.91	V
		VLVD5	When power supply rises	2.76	2.81	2.87	V
			When power supply falls	2.70	2.75	2.81	V
		VLVD6	When power supply rises	2.66	2.71	2.76	V
			When power supply falls	2.60	2.65	2.70	V
		VLVD7	When power supply rises	2.56	2.61	2.66	V
		VLVD8	When power supply falls	2.50	2.55	2.60	V
			When power supply rises	2.45	2.50	2.55	V
			When power supply falls	2.40	2.45	2.50	V
		VLVD9	When power supply rises	2.05	2.09	2.13	V
			When power supply falls	2.00	2.04	2.08	V
		VLVD10	When power supply rises	1.94	1.98	2.02	V
			When power supply falls	1.90	1.94	1.98	V
		VLVD11	When power supply rises	1.84	1.88	1.91	V
			When power supply falls	1.80	1.84	1.87	V
		VLVD12	When power supply rises	1.74	1.77	1.81	V
			When power supply falls	1.70	1.73	1.77	V
		VLVD13	When power supply rises	1.64	1.67	1.70	V
			When power supply falls	1.60	1.63	1.66	V
Minimum puls	se width	tLW		300			μs
Detection del	ay time					300	μs



RL78/L13

2.11 Timing Specifications for Switching Flash Memory Programming Modes

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Time to complete the communication for the initial setting after the external reset is released	tsuinit	POR and LVD reset must be released before the external reset is released.			100	ms
Time to release the external reset after the TOOL0 pin is set to the low level	tsu	POR and LVD reset must be released before the external reset is released.	10			μs
Time to hold the TOOL0 pin at the low level after the external reset is released (excluding the processing time of the firmware to control the flash memory)	tно	POR and LVD reset must be released before the external reset is released.	1			ms

$(T_A = -40 \text{ to } +85^{\circ}C, 1.8 \text{ V} \le \text{V}_{DD} \le 5.5 \text{ V}, \text{ V}_{SS} = 0 \text{ V})$



- <1> The low level is input to the TOOL0 pin.
- <2> The external reset is released (POR and LVD reset must be released before the external reset is released.).
- <3> The TOOL0 pin is set to the high level.
- <4> Setting of the flash memory programming mode by UART reception and completion the baud rate setting.
- **Remark** tsuinit: Communication for the initial setting must be completed within 100 ms after the external reset is released during this period.
 - $t_{\text{su:}}$ Time to release the external reset after the TOOL0 pin is set to the low level
 - thD: Time to hold the TOOL0 pin at the low level after the external reset is released (excluding the processing time of the firmware to control the flash memory)



Parameter	Symbol		Conditions	HS (high-spee	Unit	
				MIN.	MAX.	
Transfer rate		Reception	$\begin{array}{l} 4.0 \ V \leq V_{DD} \leq 5.5 \ V, \\ 2.7 \ V \leq V_b \leq 4.0 \ V \end{array}$		fмск/12 ^{Note}	bps
			Theoretical value of the maximum transfer rate f_{CLK} = 24 MHz, f_{MCK} = f_{CLK}		2.0	Mbps
			$\begin{array}{l} 2.7 \ V \leq V_{DD} < 4.0 \ V, \\ 2.3 \ V \leq V_b \leq 2.7 \ V \end{array}$		fмск/12 ^{Note}	bps
			Theoretical value of the maximum transfer rate f_{CLK} = 24 MHz, f_{MCK} = f_{CLK}		2.0	Mbps
			$\begin{array}{l} 2.4 \ V \leq V_{DD} < 3.3 \ V, \\ 1.6 \ V \leq V_b \leq 2.0 \ V \end{array}$		fмск/12 ^{Note}	bps
			Theoretical value of the maximum transfer rate f_{CLK} = 24 MHz, f_{MCK} = f_{CLK}		2.0	Mbps

(5) Communication at different potential (1.8 V, 2.5 V, 3 V) (UART mode) (1/2) (T_A = -40 to +105°C, 2.4 V \leq V_{DD} \leq 5.5 V, V_{SS} = 0 V)

Note Transfer rate in SNOOZE mode is 4800 bps only.

Caution Select the TTL input buffer for the RxDq pin and the N-ch open drain output (Vbb tolerance) mode for the TxDq pin by using port input mode register g (PIMg) and port output mode register g (POMg). For VH and VL, see the DC characteristics with TTL input buffer selected.

Remarks 1. V_b[V]: Communication line voltage

- **2.** q: UART number (q = 0 to 3), g: PIM and POM number (g = 0, 1, 3)
- fMCK: Serial array unit operation clock frequency
 (Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn). m: Unit number, n: Channel number (mn = 00 to 03, 10 to 13)



(6) Communication at different potential (1.8 V, 2.5 V, 3 V) (CSI mode) (master mode, SCKp... internal clock output) (1/2) $(T_A = -40 \text{ to } +105^{\circ}\text{C}, 2.4 \text{ V} \le \text{V}_{DD} \le 5.5 \text{ V}, \text{V}_{SS} = 0 \text{ V})$

Parameter	Symbol	Conditions		HS (high-spee	Unit	
				MIN.	MAX.	
SCKp cycle time	tkcy1	tkcyı ≥ 4/fc∟k		600		ns
			$\label{eq:VDD} \begin{array}{l} 2.7 \; V \leq V_{DD} < 4.0 \; V, \\ 2.3 \; V \leq V_b \leq 2.7 \; V, \\ C_b = 30 \; pF, \; R_b = 2.7 \; k\Omega \end{array}$	1000		ns
			$\label{eq:VDD} \begin{array}{l} 2.4 \; V \leq V_{DD} < 3.3 \; V, \\ 1.6 \; V \leq V_b \leq 1.8 \; V, \\ C_b = 30 \; pF, \; R_b = 5.5 \; k\Omega \end{array}$	2300		ns
SCKp high-level width	tкнı	$\begin{array}{l} 4.0 \; V \leq V_{DD} \leq 5.5 \; V, \; 2.7 \; V \leq V_b \leq 4.0 \; V, \\ C_b = 30 \; pF, \; R_b = 1.4 \; k\Omega \end{array}$		tĸcy1/2 – 150		ns
		$\begin{array}{l} 2.7 \; V \leq V_{DD} < 4.0 \; V, \; 2.3 \; V \leq V_b \leq 2.7 \; V, \\ C_b = 30 \; pF, \; R_b = 2.7 \; k\Omega \end{array}$		tkcy1/2 – 340		ns
		$\begin{array}{l} 2.4 \; V \leq V_{DD} < 3.3 \; V, \; 1.6 \; V \leq V_b \leq 2.0 \; V, \\ C_b = 30 \; pF, \; R_b = 5.5 \; k\Omega \end{array}$		tkcy1/2 – 916		ns
SCKp low-level width	tĸ∟1	$\begin{array}{l} 4.0 \; V \leq V_{DD} \leq 5.5 \; V, \; 2.7 \; V \leq V_b \leq 4.0 \; V, \\ C_b = 30 \; pF, \; R_b = 1.4 \; k\Omega \end{array}$		tkcy1/2 - 24		ns
		$\begin{array}{l} 2.7 \; V \leq V_{DD} < 4.0 \; V, \; 2.3 \; V \leq V_b \leq 2.7 \; V, \\ C_b = 30 \; pF, \; R_b = 2.7 \; k\Omega \end{array}$		tксү1/2 — 36		ns
		$2.4 V \le V_{DD} < C_b = 30 \text{ pF}, \text{ F}$	3.3 V , 1.6 V \leq V _b \leq 2.0 V, R _b = 5.5 kΩ	tксү1/2 — 100		ns
SIp setup time (to SCKp↑) ^{Note 1}	tsik1	$\begin{array}{l} 4.0 \ V \leq V_{DD} \leq \\ C_b = 30 \ pF, \ F \end{array}$	$ 5.5 \text{ V}, 2.7 \text{ V} \le \text{V}_{b} \le 4.0 \text{ V}, $ R _b = 1.4 kΩ	162		ns
		$2.7 V \le V_{DD} < C_b = 30 pF, F$: 4.0 V, 2.3 V \leq V _b \leq 2.7 V, R _b = 2.7 kΩ	354		ns
		$2.4 V \le V_{DD} < C_b = 30 pF, F$: 3.3 V, 1.6 V \leq V _b \leq 2.0 V, R _b = 5.5 kΩ	958		ns
SIp hold time (from SCKp↑) ^{Note 1}	tksii	$4.0 V \le V_{DD} \le C_b = 30 pF, F$	$ 5.5 \text{ V}, 2.7 \text{ V} \le \text{V}_{\text{b}} \le 4.0 \text{ V}, $ R _b = 1.4 kΩ	38		ns
		$ \begin{array}{l} 2.7 \ V \leq V_{DD} < 4.0 \ V, \ 2.3 \ V \leq V_b \leq 2.7 \ V, \\ C_b = 30 \ pF, \ R_b = 2.7 \ k\Omega \end{array} $		38		ns
		$\begin{array}{l} 2.4 \ V \leq V_{DD} < \\ C_b = 30 \ pF, \ F \end{array}$	$ = 3.3 \text{ V}, \ 1.6 \text{ V} \le \text{V}_{b} \le 2.0 \text{ V}, $ R _b = 5.5 kΩ	38		ns
Delay time from SCKp↓ to SOp output ^{Note 1}	t kso1	$\begin{array}{l} 4.0 \ V \leq V_{DD} \leq \\ C_{b} = 30 \ pF, \ F \end{array}$	$ 5.5 \text{ V}, 2.7 \text{ V} \le \text{V}_{b} \le 4.0 \text{ V}, $ R _b = 1.4 kΩ		200	ns
		$2.7 V \le V_{DD} < C_b = 30 pF, F$			390	ns
		$2.4 \text{ V} \leq \text{V}_{\text{DD}} <$ C_{b} = 30 pF, F	$ 3.3 \text{ V}, 1.6 \text{ V} \le \text{V}_{b} \le 2.0 \text{ V}, $ R _b = 5.5 kΩ		966	ns

(Note, Caution and Remark are listed on the next page.)





CSI mode serial transfer timing (master mode) (during communication at different potential) (When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1.)





Remark p: CSI number (p = 00, 10), m: Unit number, n: Channel number (mn = 00, 02), g: PIM and POM number (g = 0, 1)



3.6.5 LVD circuit characteristics

LVD Detection Voltage of Reset Mode and Interrupt Mode

(TA = -40 to +105°C, VPDR \leq VDD \leq 5.5 V, Vss = 0 V)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Detection Supply voltage level		VLVD0	When power supply rises	3.90	4.06	4.22	V
voltage			When power supply falls	3.83	3.98	4.13	V
		VLVD1	When power supply rises	3.60	3.75	3.90	V
			When power supply falls	3.53	3.67	3.81	V
		VLVD2	When power supply rises	3.01	3.13	3.25	V
			When power supply falls	2.94	3.06	3.18	V
		VLVD3	When power supply rises	2.90	3.02	3.14	V
			When power supply falls	2.85	2.96	3.07	V
		VLVD4	When power supply rises	2.81	2.92	3.03	V
			When power supply falls	2.75	2.86	2.97	V
		Vlvd5	When power supply rises	2.71	2.81	2.92	V
			When power supply falls	2.64	2.75	2.86	V
		VLVD6	When power supply rises	2.61	2.71	2.81	V
			When power supply falls	2.55	2.65	2.75	V
		VLVD7	When power supply rises	2.51	2.61	2.71	V
			When power supply falls	2.45	2.55	2.65	V
Minimum pulse width		t∟w		300			μs
Detection delay time						300	μs

LVD Detection Voltage of Interrupt & Reset Mode

(TA = -40 to +105°C, VPDR \leq VDD \leq 5.5 V, Vss = 0 V)

Parameter	eter Symbol		Conditions			TYP.	MAX.	Unit
Interrupt and reset mode	VLVD5	Vpoc2,	VPOC1, VPOC0 = 0, 1, 1,	1, VPOC0 = 0, 1, 1, falling reset voltage		2.75	2.86	V
	VLVD4		LVIS1, LVIS0 = 1, 0	Rising release reset voltage	2.81	2.92	3.03	V
				Falling interrupt voltage	2.75	2.86	2.97	V
	VLVD3 VLVD0	LVIS1, LVIS0 = 0, 1	Rising release reset voltage	2.90	3.02	3.14	V	
				Falling interrupt voltage	2.85	2.96	3.07	V
		LVIS1, LVIS0 = 0, 0	Rising release reset voltage	3.90	4.06	4.22	V	
				Falling interrupt voltage	3.83	3.98	4.13	V

3.6.6 Supply voltage rise time

$(T_A = -40 \text{ to } +105^{\circ}\text{C}, \text{ Vss} = 0 \text{ V})$

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
V _{DD} rise slope	SVDD				54	V/ms

Caution Make sure to keep the internal reset state by the LVD circuit or an external reset until V_{DD} reaches the operating voltage range shown in 3.4 AC Characteristics.







R5F10WMAAFB, R5F10WMCAFB, R5F10WMDAFB, R5F10WMEAFB, R5F10WMFAFB, R5F10WMGAFB, R5F10WMCGFB, R5F10WMCGAFB, R5W10WCGAFB, R5W10WCGAFA, R5W10WCGAFA, R5W10WCGAFA, R5W10WCGAFA, R5W10WCGAFA, R5W10WCGAFA, R5W10W

